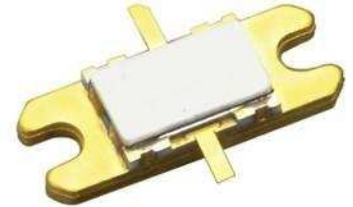


### FEATURES

- High Voltage Operation :  $V_{DS}=50V$
- High Power : 50.5dBm (typ.) @  $P_{sat}$
- High Efficiency: 65%(typ.) @  $P_{sat}$
- Power Gain : 19dB(typ.) @  $f=1.6GHz$
- Proven Reliability



### DESCRIPTION

SEI's GaN-HEMT offers high efficiency, ease of matching, greater consistency and broad bandwidth for high power L-band amplifiers with 50V operation, and gives you higher gain.

This new product is ideally suited for use in 1.5GHz W-CDMA & LTE design requirements as it offers high gain, long term reliability and ease of use.

### ABSOLUTE MAXIMUM RATINGS (Case Temperature $T_c=25deg.C$ )

Item	Symbol	Condition	Rating	Unit
Operating-Voltage	$V_{DS}$		55	V
Drain-Source Voltage	$V_{DS}$	$V_{GS}=-8V$	160	V
Gate-Source Voltage	$V_{GS}$		-15	V
Total Power Dissipation	$P_t$		97.8	W
Storage Temperature	$T_{stg}$		-65 to +175	deg.C
Channel Temperature	$T_{ch}$		250	deg.C

### RECOMMENDED OPERATING CONDITION

Item	Symbol	Condition	Limit	Unit
DC Input Voltage	$V_{DS}$		$\leq 55$	V
Forward Gate Current	$I_{GF}$	$R_G=5\text{ ohm}$	$\leq 102$	mA
Reverse Gate Current	$I_{GR}$	$R_G=5\text{ ohm}$	$\geq -3.9$	mA
Channel Temperature	$T_{ch}$		$\leq 180$	deg.C
Average Output Power	$P_{ave.}$		$\leq 47.5$	dBm

### ELECTRICAL CHARACTERISTICS (Case Temperature $T_c=25deg.C$ )

Item	Symbol	Condition	Limit			Unit
			Min.	Typ.	Max.	
Pinch-Off Voltage	$V_p$	$V_{DS}=50V\ I_{DS}=27.2mA$	-1.0	-1.5	-2.0	V
Saturated Power	$P_{sat} *1$	$V_{DS}=50V$	49.5	50.5	-	dBm
Drain Efficiency	$\eta_d *2$	$I_{DS}(DC)=400mA$	28	33	-	%
Power Gain	$G_p *2$	$f=1.6GHz$	18	19	-	dB
Thermal Resistance	$R_{th}$	Channel to Case at 52.5W $P_{DC}$	-	2.0	2.3	deg.C/W

\*1 : 10%-duty RF pulse (DC supply constant)

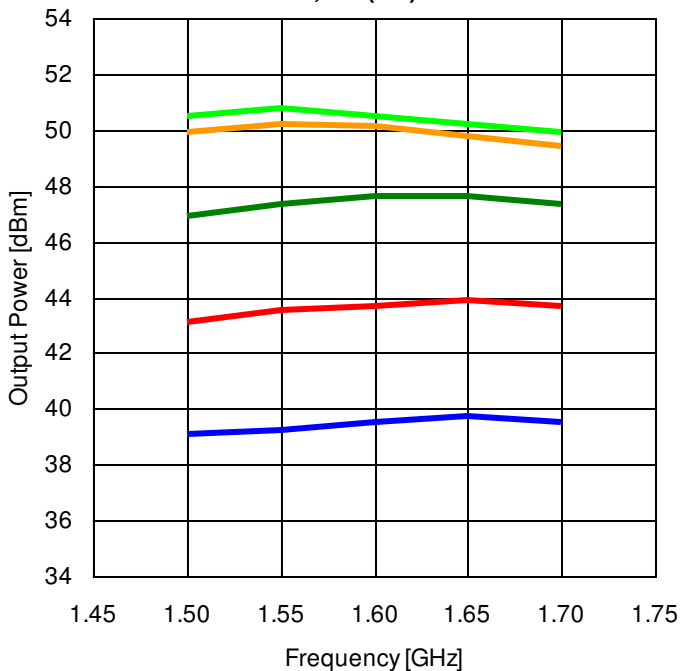
\*2 :  $P_{out} = 42.5dBm$ , CW modulation Signal (W-CDMA)

<b>RoHS COMPLIANCE</b>	<b>Yes</b>
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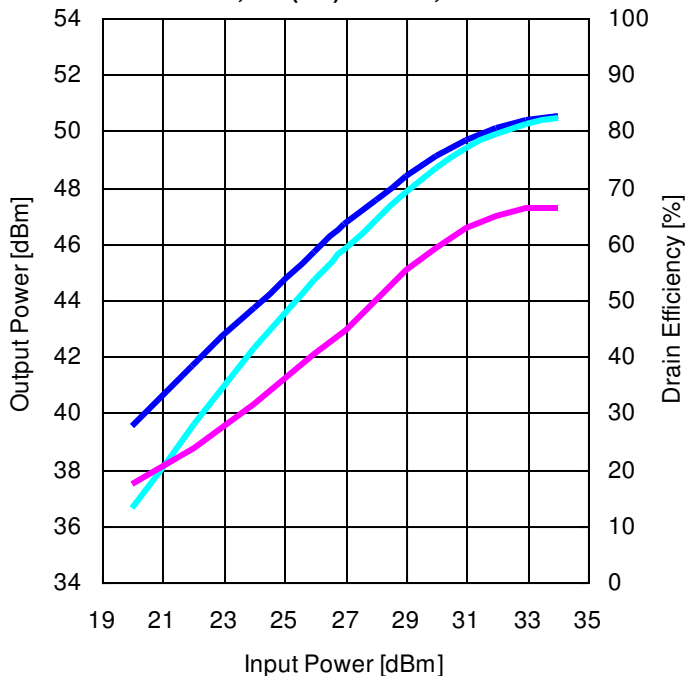
RF characteristics @f=1.6GHz fine tuned

High Voltage - High Power GaN-HEMT

Output Power vs. Frequency  
VDS=50V, IDS(DC)=400mA



Output Power and Drain Efficiency vs. Input Power  
VDS=50V, IDS(DC)=400mA, f=1.6GHz

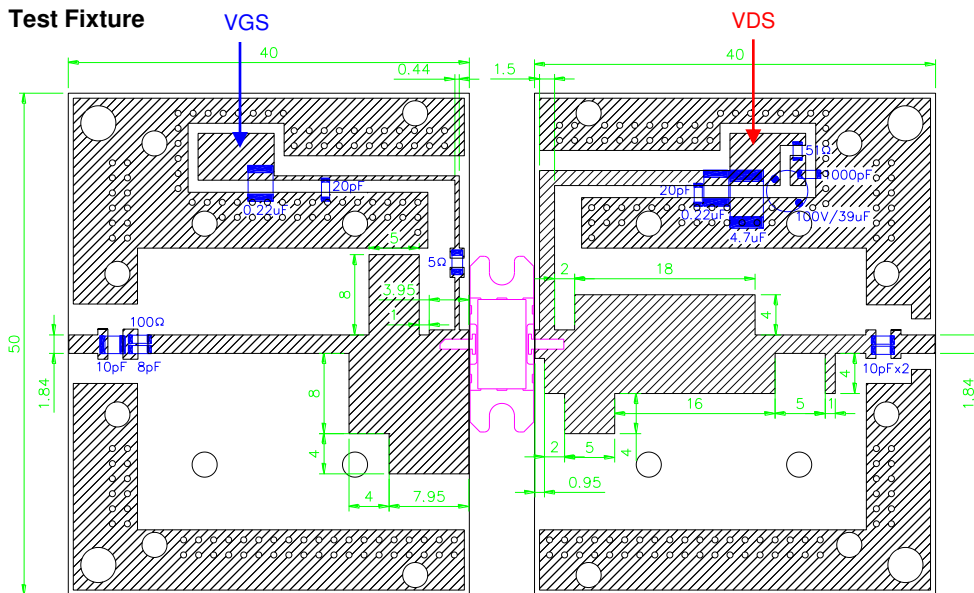


— Pin=20dBm    — Pin=24dBm    — Pin=28dBm  
— Pin=32dBm    — Pin=34dBm

— Pout (AB class)    — Pout (class B)    — Nd (class B)

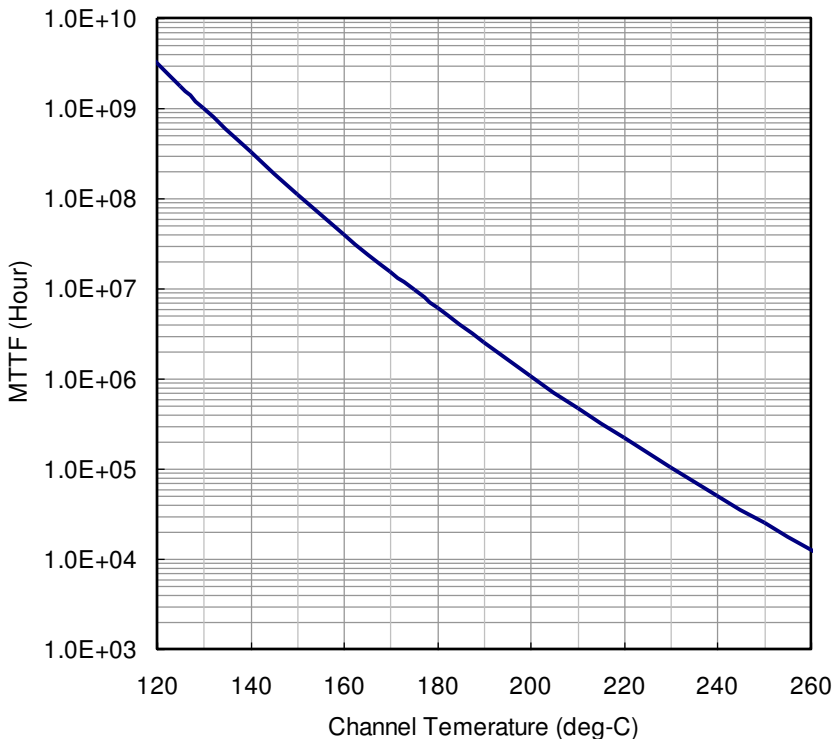
Pulse Signal (10%-duty, DC : constant)

Test Fixture



h=0.8mm εr=3.5  
Cu=18um Unit:mm

### MTTF Calculation - Estimated MTTF -



Ea=1.6eV  
Confidence Level=90%

Channel Temp (deg-C)	MTTF (Hours)
160	4.05 x 10 <sup>7</sup>
180	6.07 x 10 <sup>6</sup>
200	1.07 x 10 <sup>6</sup>

$$AF = \exp\left[-\frac{Ea}{k}\left(\frac{1}{T_{stress}} - \frac{1}{T_{use}}\right)\right]$$

$$MTTF_{use} = MTTF_{stress} * AF$$

Where;

AF: acceleration factor

Ea: activation energy (1.6 eV)

k: Boltzman's constant ( $8.62 \times 10^{-5}$  eV/K)

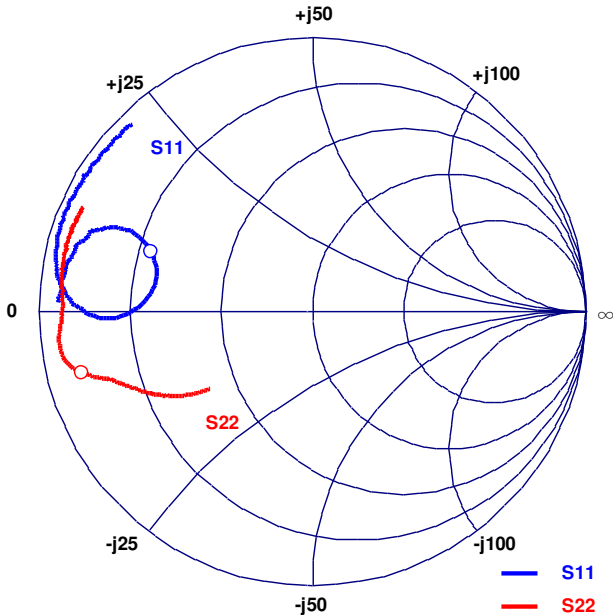
T<sub>stress</sub>: stress temperature (K)

T<sub>use</sub>: use temperature (K)

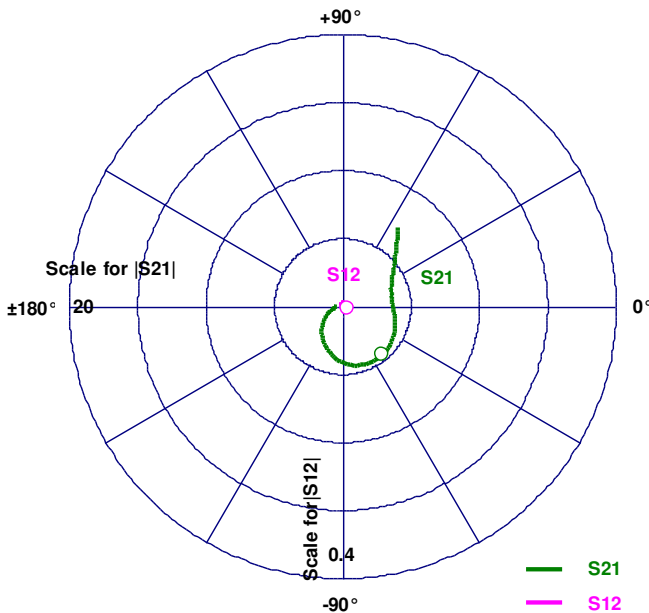
### ESD characteristic

Test Methodology	Class
Human Body Model (per JESD22-A114)	1A
Machine Model (per JEIA/ESD22-A115)	A

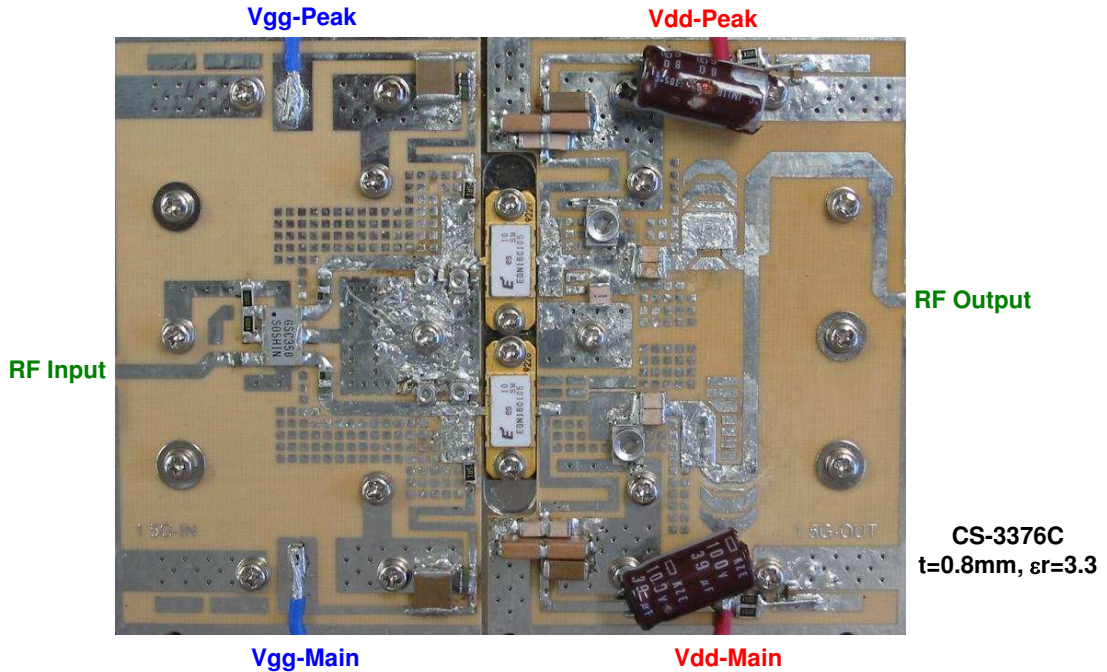
S-Parameters @VDS=50V, IDS(DC)=400mA, f=0.5 to 4.5GHz  
 ZI = Zs = 50 ohm      Marker : 1.6GHz



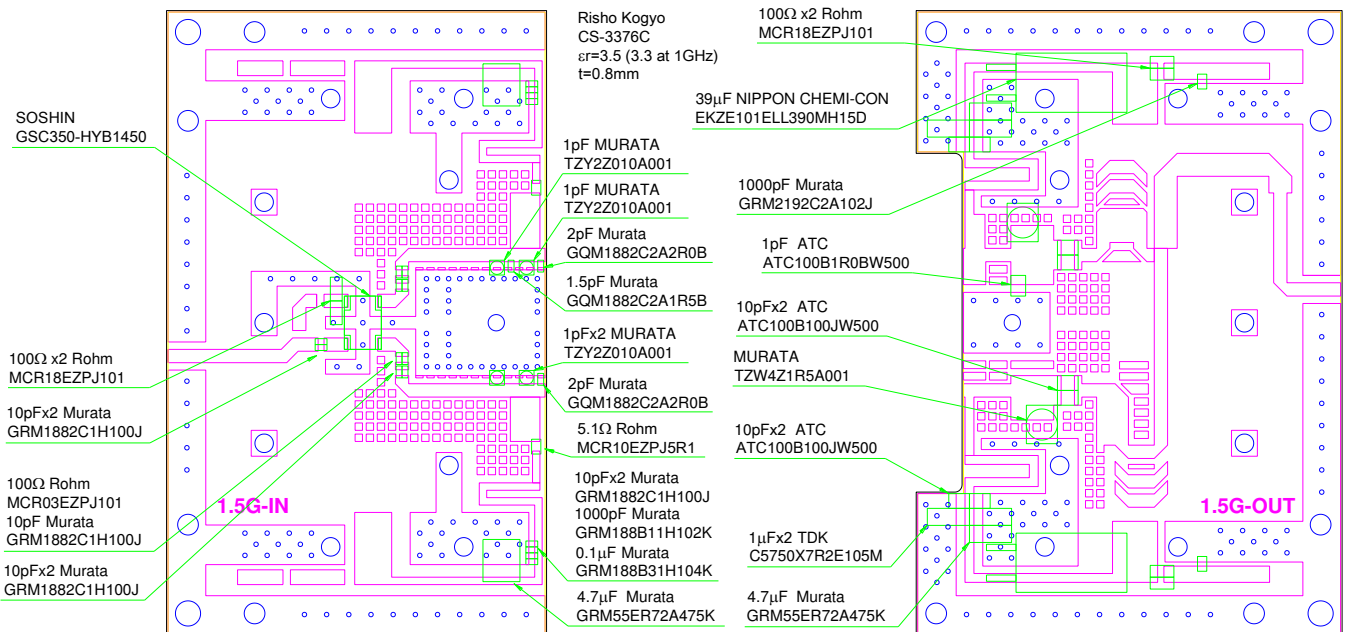
Freq. GHz	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.50	0.93	178.19	7.04	54.80	0.005	-4.93	0.47	-142.69
0.60	0.92	175.95	5.83	47.31	0.005	-3.55	0.52	-144.79
0.70	0.92	173.65	5.07	40.30	0.005	-0.79	0.57	-147.02
0.80	0.92	171.75	4.47	33.96	0.005	-0.42	0.61	-149.50
0.90	0.92	169.80	4.08	27.41	0.005	2.93	0.65	-152.03
1.00	0.90	167.74	3.85	20.49	0.005	5.77	0.68	-154.35
1.10	0.89	165.41	3.70	13.56	0.005	7.86	0.71	-156.43
1.20	0.88	163.26	3.66	5.80	0.005	12.46	0.74	-158.51
1.30	0.86	160.36	3.76	-3.05	0.006	9.03	0.76	-160.33
1.40	0.81	158.00	3.97	-14.11	0.006	6.85	0.79	-161.62
1.50	0.73	156.17	4.35	-29.41	0.007	-4.88	0.83	-162.82
1.60	0.62	159.87	4.63	-51.03	0.007	-24.98	0.87	-164.96
1.70	0.59	173.82	4.44	-78.55	0.006	-51.43	0.92	-168.44
1.80	0.72	-177.87	3.52	-105.63	0.004	-84.06	0.93	-172.87
1.90	0.83	-179.77	2.54	-125.84	0.002	-129.39	0.92	-175.94
2.00	0.90	176.85	1.81	-139.83	0.001	168.40	0.92	-177.82
2.10	0.93	173.61	1.33	-149.73	0.002	123.33	0.92	-179.69
2.20	0.94	170.97	1.00	-156.70	0.003	104.12	0.91	179.26
2.30	0.95	168.60	0.78	-162.75	0.003	94.17	0.91	178.02
2.40	0.96	166.62	0.62	-167.67	0.004	90.46	0.91	176.97
2.50	0.96	164.93	0.50	-171.51	0.005	86.35	0.91	175.86
2.60	0.97	163.29	0.41	-176.26	0.006	82.64	0.92	174.65
2.70	0.97	161.89	0.35	-179.53	0.006	83.49	0.92	173.62
2.80	0.97	160.32	0.29	176.53	0.007	77.21	0.92	172.53
2.90	0.97	159.31	0.25	173.78	0.007	79.98	0.92	171.64
3.00	0.97	157.89	0.22	170.39	0.007	79.64	0.93	170.81
3.10	0.97	156.86	0.19	167.79	0.008	78.29	0.92	169.55
3.20	0.97	155.17	0.17	164.01	0.008	78.99	0.92	168.78
3.30	0.97	154.01	0.15	160.67	0.009	77.11	0.93	167.82
3.40	0.97	152.37	0.13	159.19	0.009	77.58	0.93	166.82
3.50	0.97	151.07	0.12	155.47	0.010	79.52	0.93	165.85
3.60	0.97	149.56	0.11	151.47	0.011	78.79	0.93	164.81
3.70	0.96	148.09	0.10	148.14	0.011	77.35	0.93	163.96
3.80	0.96	146.57	0.09	144.90	0.013	78.64	0.93	163.02
3.90	0.96	145.08	0.09	141.08	0.014	78.82	0.93	161.94
4.00	0.96	143.21	0.08	136.84	0.016	76.52	0.93	160.93
4.10	0.95	141.90	0.08	132.38	0.017	73.28	0.93	160.23
4.20	0.96	139.47	0.07	132.09	0.019	72.83	0.92	159.16
4.30	0.95	138.10	0.07	121.79	0.020	67.30	0.92	158.11
4.40	0.95	135.75	0.07	116.37	0.021	63.70	0.92	156.67
4.50	0.95	133.94	0.06	113.07	0.023	60.77	0.92	155.78



**Doherty Amplifier drawing**

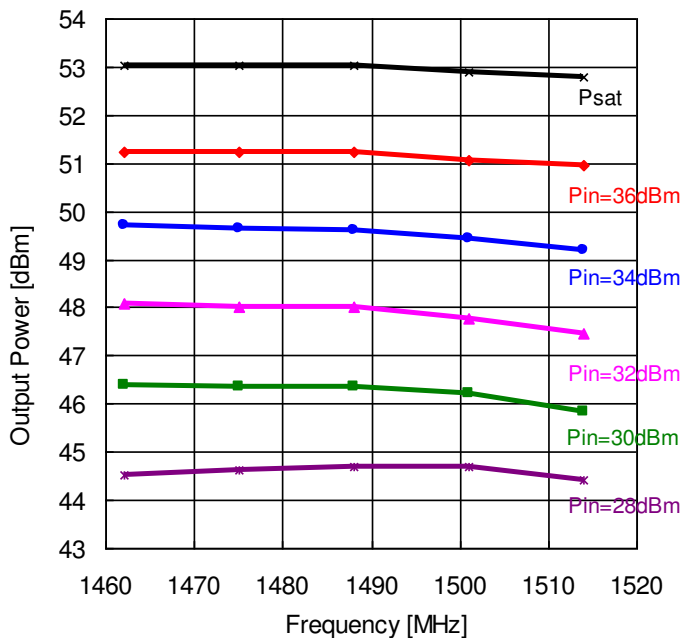
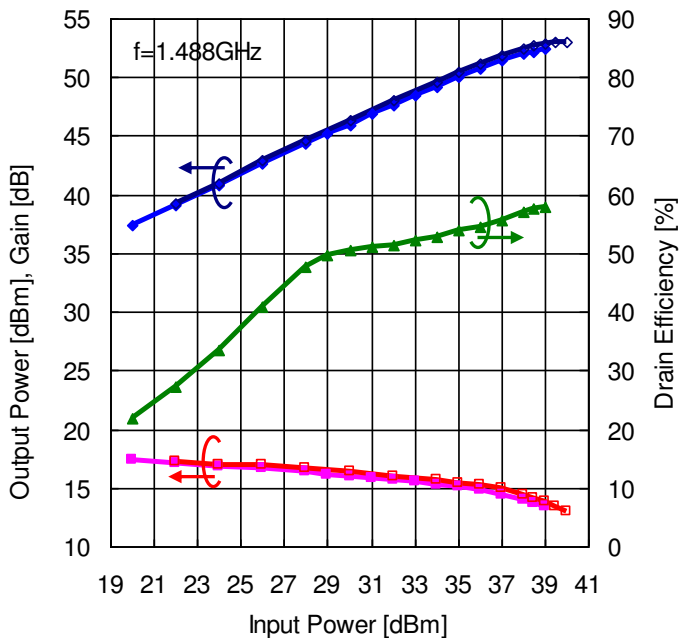


**Test Fixture**



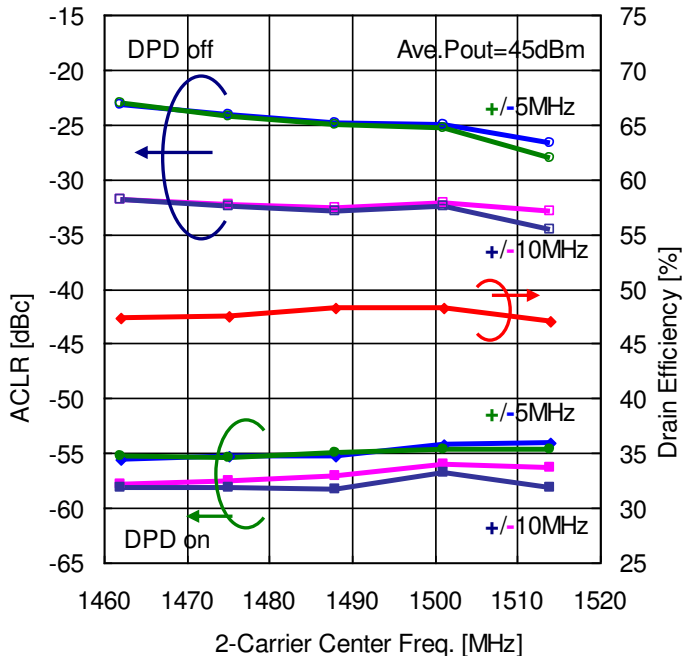
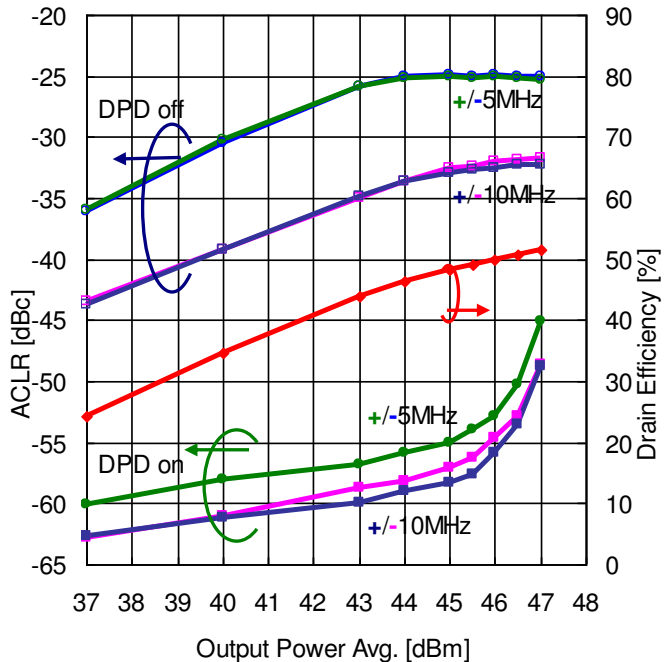
**Doherty Amplifier characteristics**

Test conditions :  $V_{ds}=50V$ ,  $I_{ds-main}=400mA$ ,  $V_{gs-peak}=-3.5V$ , Pulse Duty : 10% (12us/120us)

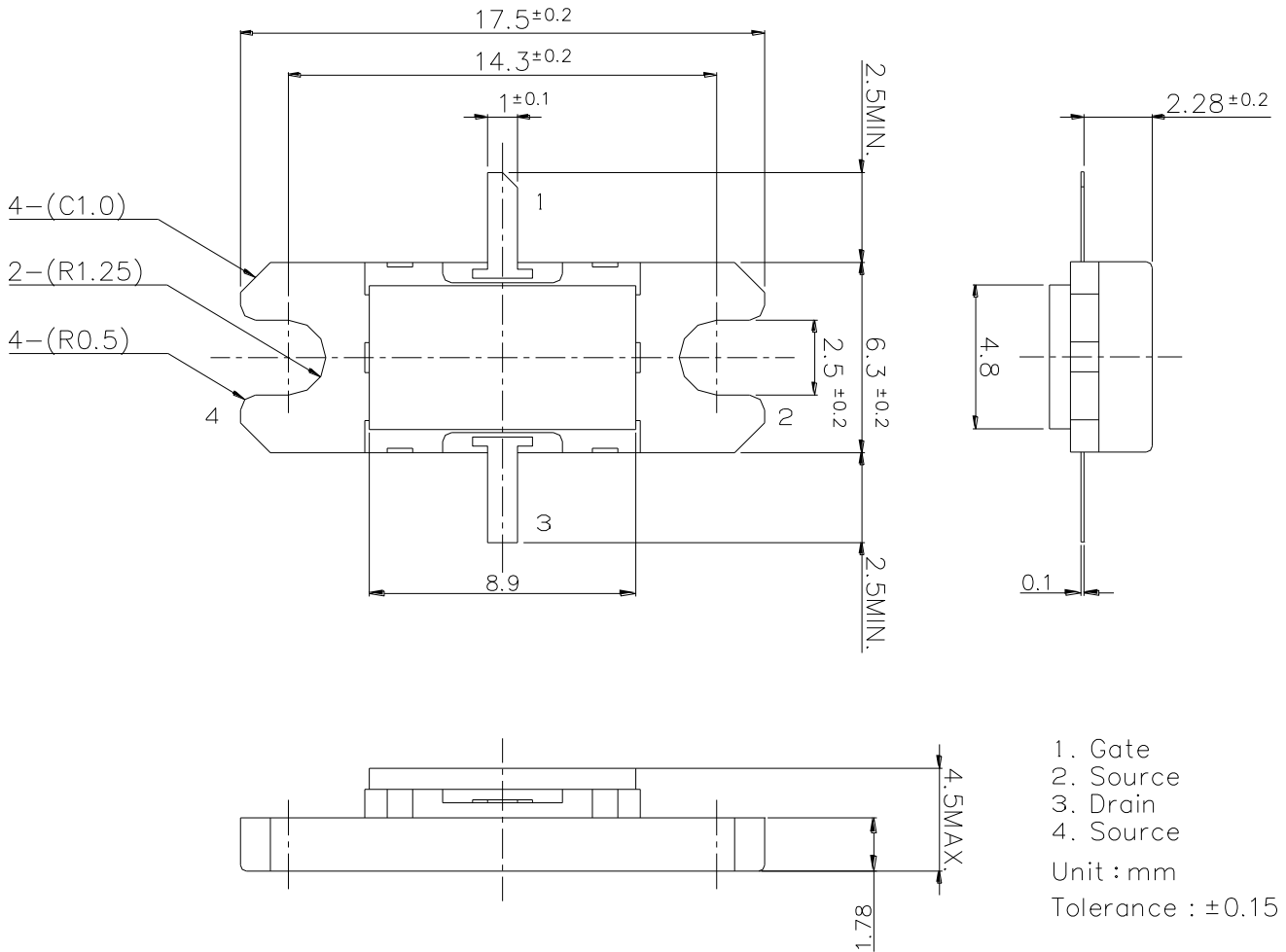


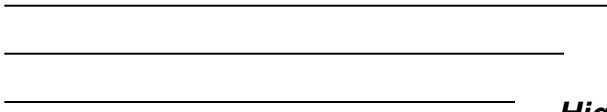
Test conditions :  $V_{ds}=50V$ ,  $I_{ds-main}=400mA$ ,  $V_{gs-peak}=-3.5V$

W-CDMA 2-carrier, 5MHz Spacing, PAR=7.8dB(0.01%),  $f_1=1485.5MHz$ ,  $f_2=1490.5MHz$



### MK Package Outline Metal-Ceramic Hermetic Package





# ***EGN16C105MK***

***High Voltage - High Power GaN-HEMT***

**For further information please contact:**

**<http://global-sei.com/Electro-optic/about/office.html>**